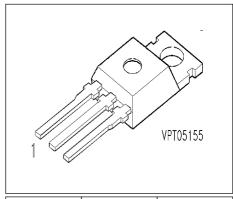
### **SIPMOS** ® Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated



Pin 1	Pin 2	Pin 3
G	D	S

Туре	V <sub>DS</sub>	I <sub>D</sub>	R <sub>DS(on)</sub>	Package	Ordering Code
BUZ 41 A	500 V	4.5 A	1.5 Ω	TO-220 AB	C67078-S1306-A3

## **Maximum Ratings**

Parameter	Symbol	Values	Unit
Continuous drain current	I <sub>D</sub>		Α
$T_{\rm C}$ = 36 °C		4.5	
Pulsed drain current	I <sub>Dpuls</sub>		
$T_{\rm C}$ = 25 °C		18	
Avalanche current, limited by $T_{jmax}$	I <sub>AR</sub>	4.5	
Avalanche energy, periodic limited by $T_{jmax}$	E <sub>AR</sub>	8	mJ
Avalanche energy, single pulse	E <sub>AS</sub>		
$I_{\rm D} = 4.5 \; {\rm A}, \; V_{\rm DD} = 50 \; {\rm V}, \; R_{\rm GS} = 25 \; {\rm \Omega}$			
$L = 28.4 \text{ mH}, T_j = 25 \text{ °C}$		320	
Gate source voltage	$V_{\mathrm{GS}}$	± 20	V
Power dissipation	P <sub>tot</sub>		W
$T_{\rm C}$ = 25 °C		75	
Operating temperature	T <sub>j</sub>	-55 <b>+</b> 150	°C
Storage temperature	T <sub>stg</sub>	-55 <b>+</b> 150	
Thermal resistance, chip case	R <sub>thJC</sub>	≤ 1.67	K/W
Thermal resistance, chip to ambient	$R_{thJA}$	75	
DIN humidity category, DIN 40 040		Е	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	



## **Electrical Characteristics**, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain- source breakdown voltage	V <sub>(BR)DSS</sub>				V
$V_{\rm GS}$ = 0 V, $I_{\rm D}$ = 0.25 mA, $T_{\rm j}$ = 25 °C		500	-	-	
Gate threshold voltage	V <sub>GS(th)</sub>				
$V_{\text{GS}} = V_{\text{DS}}$ , $I_{\text{D}} = 1 \text{ mA}$		2.1	3	4	
Zero gate voltage drain current	I <sub>DSS</sub>				μΑ
$V_{\rm DS} = 500 \; \rm V, \; V_{\rm GS} = 0 \; \rm V, \; T_{\rm j} = 25 \; ^{\circ}\rm C$		-	0.1	1	
$V_{\rm DS} = 500 \; \rm V, \; V_{\rm GS} = 0 \; \rm V, \; T_{\rm j} = 125 \; ^{\circ}\rm C$		-	10	100	
Gate-source leakage current	I <sub>GSS</sub>				nA
$V_{GS} = 20 \text{ V}, \ V_{DS} = 0 \text{ V}$		-	10	100	
Drain-Source on-resistance	R <sub>DS(on)</sub>				Ω
$V_{GS} = 10 \text{ V}, I_{D} = 3 \text{ A}$		-	1.3	1.5	



# **Electrical Characteristics**, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Transconductance	<i>g</i> fs				S
$V_{DS} \ge 2 * I_D * R_{DS(on)max}, I_D = 3 A$		2.5	4.3	-	
Input capacitance	$C_{iss}$				pF
$V_{GS} = 0 \text{ V}, \ V_{DS} = 25 \text{ V}, \ f = 1 \text{ MHz}$		-	850	1300	
Output capacitance	$C_{\rm oss}$				
$V_{GS} = 0 \text{ V}, \ V_{DS} = 25 \text{ V}, \ f = 1 \text{ MHz}$		-	100	150	
Reverse transfer capacitance	C <sub>rss</sub>				
$V_{GS} = 0 \text{ V}, \ V_{DS} = 25 \text{ V}, \ f = 1 \text{ MHz}$		-	40	60	
Turn-on delay time	$t_{d(on)}$				ns
$V_{\rm DD} = 30 \; {\rm V}, \; V_{\rm GS} = 10 \; {\rm V}, \; I_{\rm D} = 2.6 \; {\rm A}$					
$R_{\rm GS} = 50 \ \Omega$		-	15	20	
Rise time	$t_{r}$				
$V_{\rm DD}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 2.6 A					
$R_{\rm GS} = 50 \ \Omega$		-	50	70	
Turn-off delay time	t <sub>d(off)</sub>				
$V_{\rm DD}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 2.6 A					
$R_{\rm GS} = 50~\Omega$		-	140	190	
Fall time	<i>t</i> <sub>f</sub>				
$V_{\rm DD} = 30 \; {\rm V}, \; V_{\rm GS} = 10 \; {\rm V}, \; I_{\rm D} = 2.6 \; {\rm A}$					
$R_{\rm GS} = 50 \ \Omega$		-	50	70	

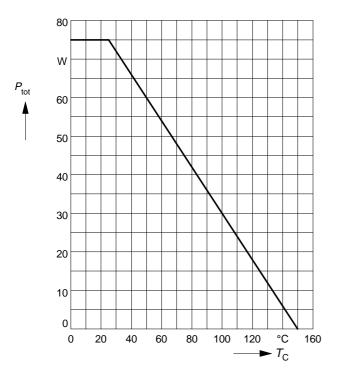


## **Electrical Characteristics**, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Inverse diode continuous forward current	Is				А
<i>T</i> <sub>C</sub> = 25 °C		-	-	4.5	
Inverse diode direct current,pulsed	/ <sub>SM</sub>				
<i>T</i> <sub>C</sub> = 25 °C		-	-	18	
Inverse diode forward voltage	V <sub>SD</sub>				V
$V_{GS} = 0 \text{ V}, I_{F} = 9 \text{ A}$		-	1	1.2	
Reverse recovery time	t <sub>rr</sub>				ns
$V_{R} = 100 \text{ V}, I_{F} = I_{S}, di_{F}/dt = 100 \text{ A/}\mu\text{s}$		-	350	-	
Reverse recovery charge	Q <sub>rr</sub>				μC
$V_{R} = 100 \text{ V}, I_{F} = I_{S}, dI_{F}/dt = 100 \text{ A/}\mu\text{s}$		-	3	-	

### **Power dissipation**

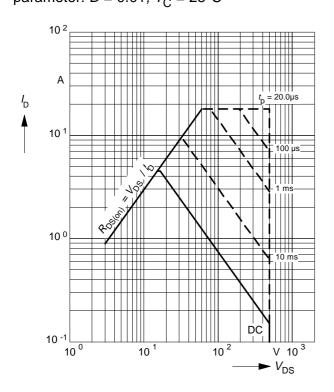
$$P_{\mathsf{tot}} = f(T_{\mathsf{C}})$$



### Safe operating area

$$I_{\mathsf{D}} = f(V_{\mathsf{DS}})$$

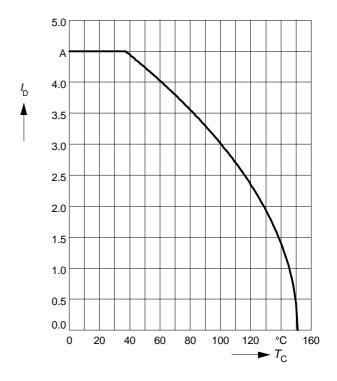
parameter: D = 0.01,  $T_C = 25$ °C



#### **Drain current**

 $I_{\mathsf{D}} = f(T_{\mathsf{C}})$ 

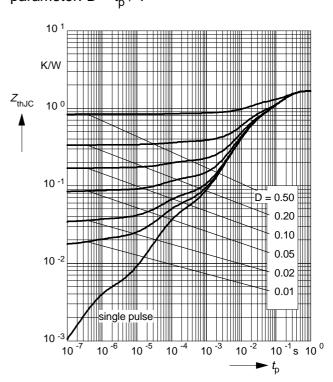
parameter:  $V_{GS} \ge 10 \text{ V}$ 



#### **Transient thermal impedance**

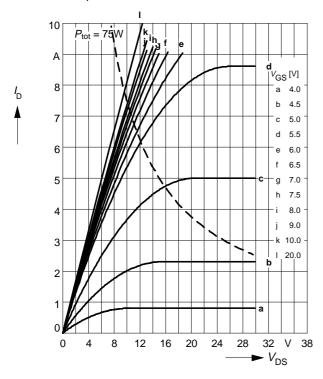
$$Z_{\mathsf{th\ JC}} = f(t_{\mathsf{p}})$$

parameter:  $D = t_p / T$ 



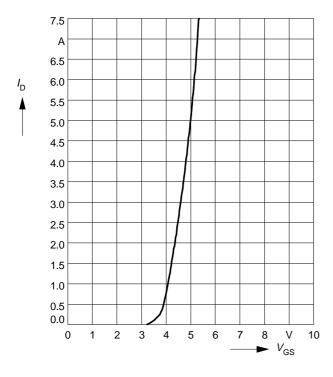
### Typ. output characteristics

 $I_{\rm D} = f(V_{\rm DS})$  parameter:  $t_{\rm p} = 80~\mu{\rm s}$ 



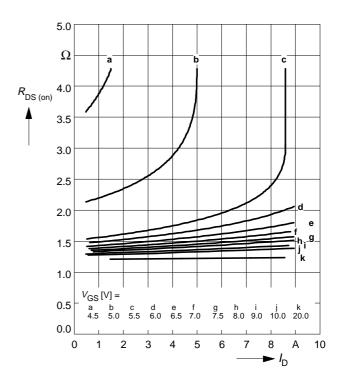
Typ. transfer characteristics  $I_D = f(V_{GS})$ 

parameter:  $t_p = 80 \mu s$  $V_{DS} \ge 2 \times I_D \times R_{DS(on)max}$ 



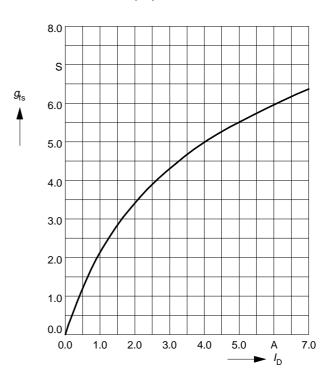
#### Typ. drain-source on-resistance

 $R_{\text{DS (on)}} = f(I_{\text{D}})$  parameter:  $V_{\text{GS}}$ 



Typ. forward transconductance  $g_{fS} = f(I_D)$ 

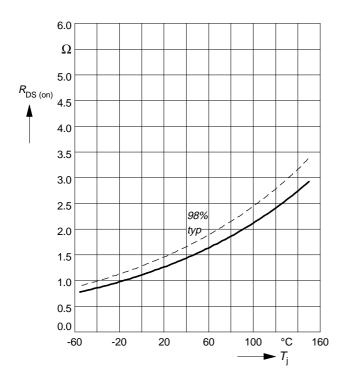
parameter:  $t_p = 80 \mu s$ ,  $V_{DS} \ge 2 \times I_D \times R_{DS(on)max}$ 



#### **Drain-source on-resistance**

 $R_{\text{DS (on)}} = f(T_{\text{j}})$ 

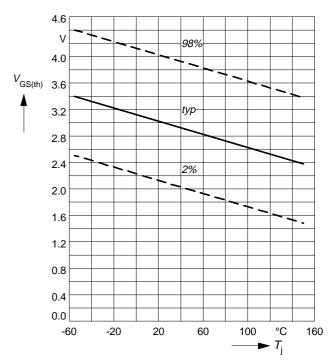
parameter:  $I_D = 3 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$ 



#### Gate threshold voltage

 $V_{GS (th)} = f(T_j)$ 

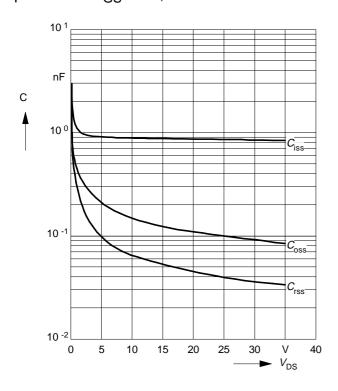
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = 1 \text{ mA}$ 



#### Typ. capacitances

 $C = f(V_{DS})$ 

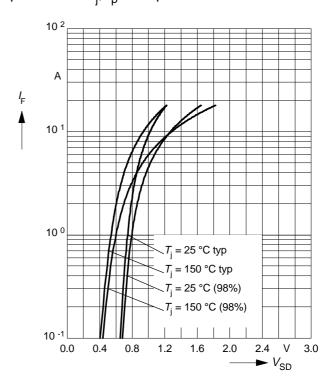
parameter:  $V_{GS} = 0V$ , f = 1MHz



#### Forward characteristics of reverse diode

 $I_{\mathsf{F}} = f(V_{\mathsf{SD}})$ 

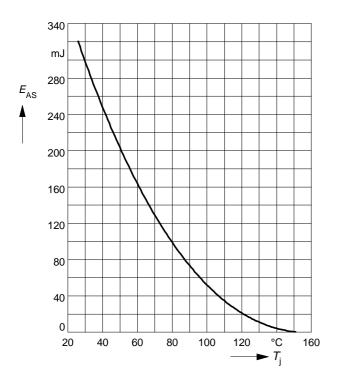
parameter:  $T_i$ ,  $t_D = 80 \mu s$ 



## Avalanche energy $E_{AS} = f(T_j)$

parameter:  $I_D = 4.5 \text{ A}$ ,  $V_{DD} = 50 \text{ V}$ 

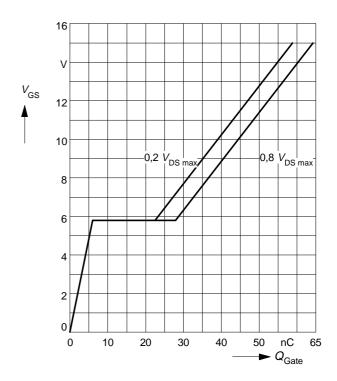
 $R_{\mathrm{GS}}$  = 25  $\Omega$ , L = 28.4 mH



#### Typ. gate charge

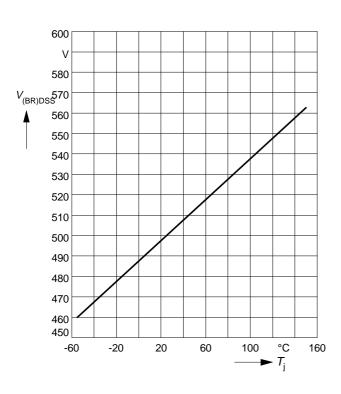
 $V_{\mathsf{GS}} = f(Q_{\mathsf{Gate}})$ 

parameter:  $I_{D \text{ puls}} = 7 \text{ A}$ 



### Drain-source breakdown voltage

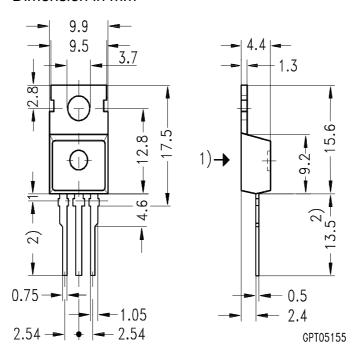
$$V_{(BR)DSS} = f(T_i)$$



### **Package Outlines**

TO-220 AB

Dimension in mm



- 1) punch direction, burr max. 0.04
- 2) dip tinning
- 3) max. 14.5 by dip tinning press burr max. 0.05